



4A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER PowerDl®5

Features

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- Very Low Leakage Current
- High Maximum Junction Temperature Capability
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Polarity: See Diagram
- Weight: 0.096 grams (approximate)



Top View



LEFT PIN O BOTTOMSIDE HEAT SINK RIGHT PIN O-

Note: Pins Left & Right must be electrically connected at the printed circuit board.

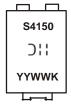
Ordering Information (Note 2)

Part Number	Case	Packaging
PDS4150-13	PowerDI [®] 5	5000/Tape & Reel

1 of 5

1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes. Notes: 2. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S4150 = Product type marking code The Manufacturers' code marking YYWW = Date code marking YY = Last two digits of year (ex: 05 for 2005) WW = Week code (01 - 53) K = Factory Designator



Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	150	>
RMS Reverse Voltage	V _{R(RMS)}	106	V
Average Rectified Output Current (See also figure 4)	Io	4	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	180	Α

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Soldering Point	$R_{ heta JS}$	_	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T _{A =} 25°C	$R_{ heta JA}$	90	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T _{A =} 25°C	$R_{ hetaJA}$	60	_	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T _{A =} 25°C	$R_{ hetaJA}$	40	_	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to	+175	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	150	_	_	V	$I_R = 10\mu A$
Forward Voltage	VF		0.71 0.57 0.77 0.63	0.76 0.64 0.81 0.70	V	I _F = 4A, T _S = 25°C I _F = 4A, T _S = 125°C I _F = 8A, T _S = 25°C I _F = 8A, T _S = 125°C
Reverse Leakage Current (Note 6)	I _R	_	0.3 0.4	10 4.5		T _S = 25°C, V _R = 150V T _S = 125°C, V _R = 150V

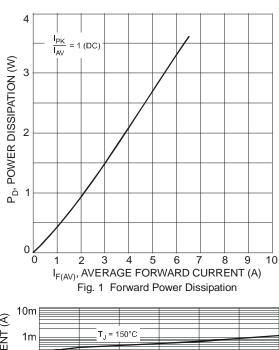
Notes:

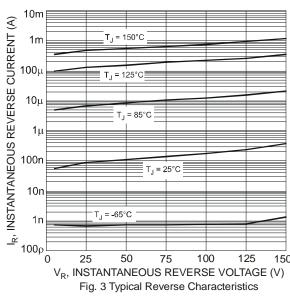
- 3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 4. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.

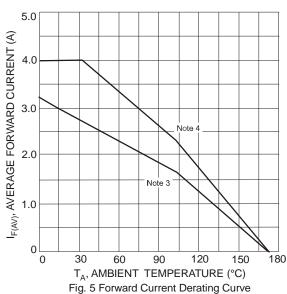
 5. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.

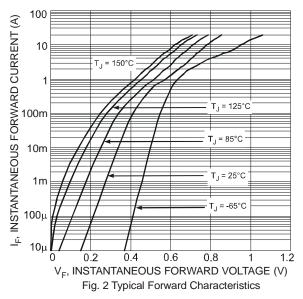
 6. Short duration pulse test used to minimize self-heating effect.

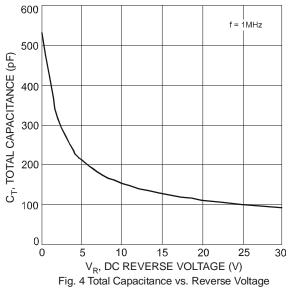


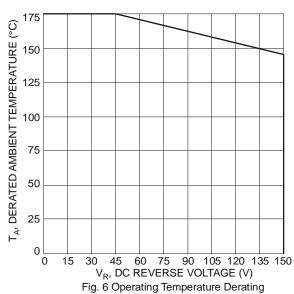








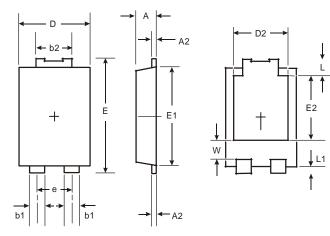




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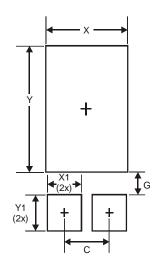


Package Outline Dimensions



PowerDI [®] 5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84 Typ			
E1	5.30	5.45		
E2	3.549 Typ			
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Y	4.860
Y1	1 400



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